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Texas Instruments SN74ALB16245DGVR

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Datasheet of SN74ALB16245DGVR - IC TRANSCVR TRI-ST 16BIT 48TVSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

	3.3-V ALB 16-BIT TRANSCEIVER WITH 3-STATE OUTPUTS SCBS678C – SEPTEMBER 1996 – REVISED JANUARY 2001
 Member of Texas Instruments' Widebus™	DGG, DGV, OR DL PACKAGE
Family	(TOP VIEW)
 State-of-the-Art Advanced Low-Voltage	1DIR 1 48 1 0E
BiCMOS (ALB) Technology Design for 3.3-V	1B1 2 47 1A1
Operation	1B2 3 46 1A2
 Schottky Diodes on All Inputs to Eliminate	GND 4 45 GND
Overshoot and Undershoot	1B3 5 44 1 1A3
 Industry Standard '16245 Pinout 	1B4 [6 43] 1A4
 Distributed V_{CC} and GND Pins Minimize	V _{CC} [] 7 42]] V _{CC}
High-Speed Switching Noise	1B5 [] 8 41 [] 1A5
 Flow-Through Architecture Optimizes PCB	1B6 9 40 1A6
Layout	GND 10 39 GND
description	1B7 11 38 1A7 1B8 12 37 1A8
The SN74ALB16245 is a 16-bit transceiver	2B1 13 36 2A1 2B2 14 35 2A2

The designed for high-speed, low-voltage (3.3-V) V_{CC} operation. This device is intended to replace the conventional transceiver in any speed-critical path. The small propagation delay is achieved using a unity-gain amplifier on the input and feedback resistors from input to output, which allows the output to track the input with a small offset voltage.

This device can be used as two 8-bit transceivers or one 16-bit transceiver. It allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so that the buses are effectively isolated.

1B6 🛛	9	40	1A6
GND	10	39] GND
1B7 🛛	11	38] 1A7
1B8 🛛	12	37	1A8
2B1	13	36	2A1
2B2	14	35	2A2
GND [15	34] GND
2B3 🛛	16	33	2A3
2B4 🛛	17	32	2A4
Vcc	18	31] v _{cc}
2B5 🛛	19	30	2A5
2B6 🛛	20	29	2A6
GND	21	28] GND
2B7 🛛	22	27	2A7
2B8		26	2A8
2DIR	24	25	20E

SN74ALB16245

ORDERING INFORMATION

TA	PACKA	AGE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	SSOP – DL		SN74ALB16245DL	ALB16245
10°C to 95°C	330P - DL	Tape and reel	SN74ALB16245DLR	ALD10245
–40°C to 85°C	TSSOP – DGG Tape and reel		SN74ALB16245DGGR	ALB16245
	TVSOP – DGV	Tape and reel	SN74ALB16245DGVR	AV245

[†]Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus is a trademark of Texas Instruments

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



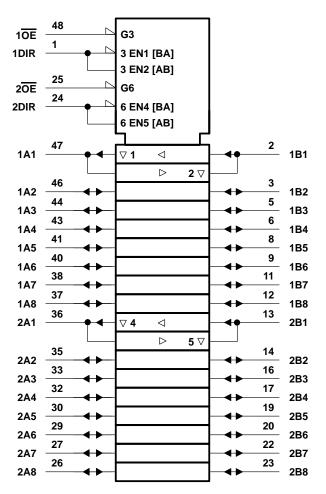
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FUNCTION TABLE (each 8-bit section)								
INP	UTS	OPERATION						
OE	DIR	OPERATION						
L	L	B data to A bus						
L	н	A data to B bus						
н	Х	Isolation						

logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



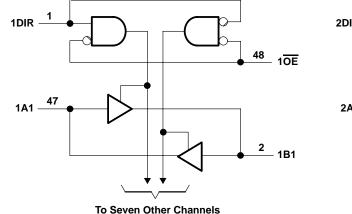


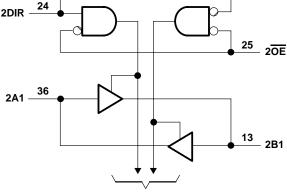
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logic diagram (positive logic)





To Seven Other Channels

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC}	–0.5 V to 4.6 V
Input voltage range, VI: Except I/O ports (see Note 1)	–0.5 V to 4.6 V
I/O ports (see Notes 1 and 2)	–0.5 V to V _{CC} + 0.5 V
Output voltage range, V _O (see Notes 1 and 2)	–0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	±50 mA
Continuous current through each V _{CC} or GND	
Package thermal impedance, θ_{JA} (see Note 3): DGG package	70°C/W
DGV package	58°C/W
DL package	63°C/W
Storage temperature range, T _{stg}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

- 2. This value is limited to 4.6 V maximum.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

			MIN	MAX	UNIT
VCC	Supply voltage		3	3.6	V
^I ОН [‡]	High-level output current			-25	mA
IOL‡	Low-level output current			25	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		5	ns/V
TA	Operating free-air temperature		-40	85	°C

[‡]See Figures 1 and 2 for typical I/O ranges.





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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PA	RAMETER		TEST CONDITION	MIN	түр†	MAX	UNIT	
	A as B sorts		lj = 18 mA	lj = 18 mA			V _{CC} +1.2	v
VIK	A or B ports	V _{CC} = 3 V	Ij = -18 mA			-0.9	-1.2	v
	Control inputs	V _{CC} = 3.6 V,	$V_I = V_{CC} \text{ or } GND$				±10	μA
				OE low		0.4	0.6	mA
Ц	II A or B ports		$A^{I} = A^{CC}$	OE high			25	μA
		A or B ports $V_{CC} = 3.6 V$	N/- 0	OE low		-0.7	-1	mA
			$V_{I} = 0$	OE high			-60	μA
IOZH		V _{CC} = 3.6 V,	V _O = 3 V			0.7	20	μA
IOZL		V _{CC} = 3.6 V,	V _O = 0.5 V			-0.2	-50	μA
ICC/p	uffer	V _{CC} = 3.6 V,	IO = 0,	$V_I = V_{CC} \text{ or } GND$		3.7	5.6	mA
ICCZ		V _{CC} = 3.6 V,	Control inputs = V _C	Control inputs = V _{CC} or GND				mA
∆lcc‡	ΔI_{CC} [‡] V _{CC} = 3 V to 3.6 V, One input at V _{CC} - 0.6 V, Other inputs at V _{CC} or GND						600	μA
Ci						3.5		pF
Cio	$V_{O} = 3 V \text{ or } 0$					7.5		pF

[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

[‡] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 3)

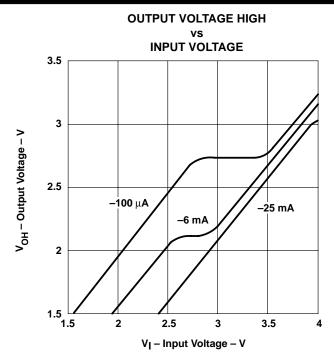
PARAMETER	FROM	то	V _{CC} =	= 3.3 V \pm	0.3 V	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP†	MAX	UNIT	
^t pd	A or B	B or A	0.6	1.3	2	ns	
^t en	OE	A or B	1.5	3.2	6	ns	
t _{dis}	OE	A or B	1.8	2.8	4.2	ns	

[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C.





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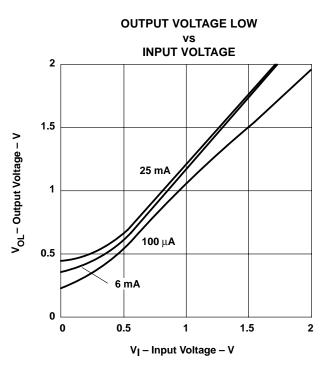


Figure 2. VOL Over Recommended Free-Air Temperature Range

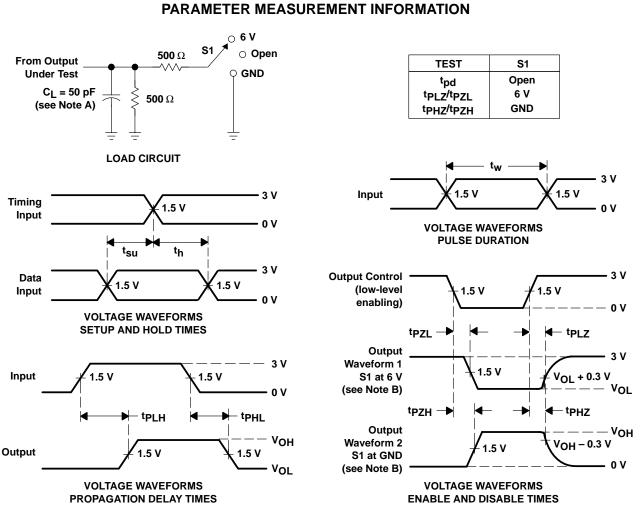




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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_f ≤ 2.5 ns, t_f ≤ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. tpLH and tpHL are the same as t_{pd} .

Figure 3. Load Circuit and Voltage Waveforms







PACKAGE OPTION ADDENDUM

18-Sep-2008

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74ALB16245DGGRE4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ALB16245DGGRG4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ALB16245DGVRE4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ALB16245DGVRG4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALB16245DGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALB16245DGVR	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALB16245DL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALB16245DLG4	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALB16245DLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALB16245DLRG4	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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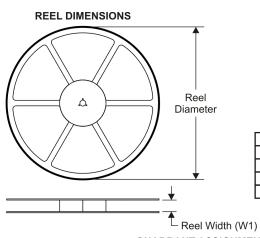
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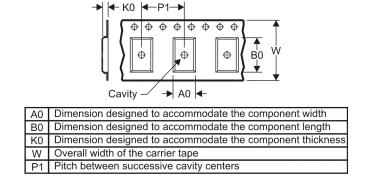
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11-Aug-2009

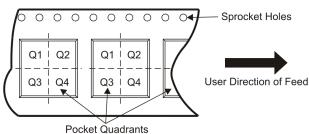
TAPE AND REEL INFORMATION





TAPE DIMENSIONS

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALB16245DGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	15.8	1.8	12.0	24.0	Q1
SN74ALB16245DGVR	TVSOP	DGV	48	2000	330.0	16.4	7.1	10.2	1.6	12.0	16.0	Q1
SN74ALB16245DLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1



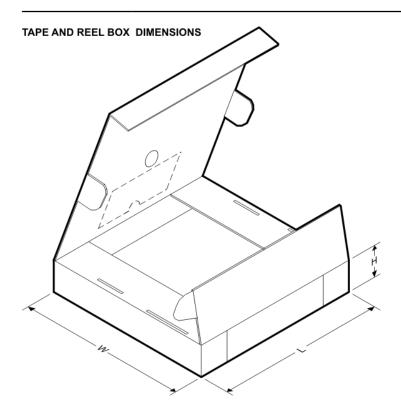
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PACKAGE MATERIALS INFORMATION

11-Aug-2009



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALB16245DGGR	TSSOP	DGG	48	2000	346.0	346.0	41.0
SN74ALB16245DGVR	TVSOP	DGV	48	2000	346.0	346.0	33.0
SN74ALB16245DLR	SSOP	DL	48	1000	346.0	346.0	49.0

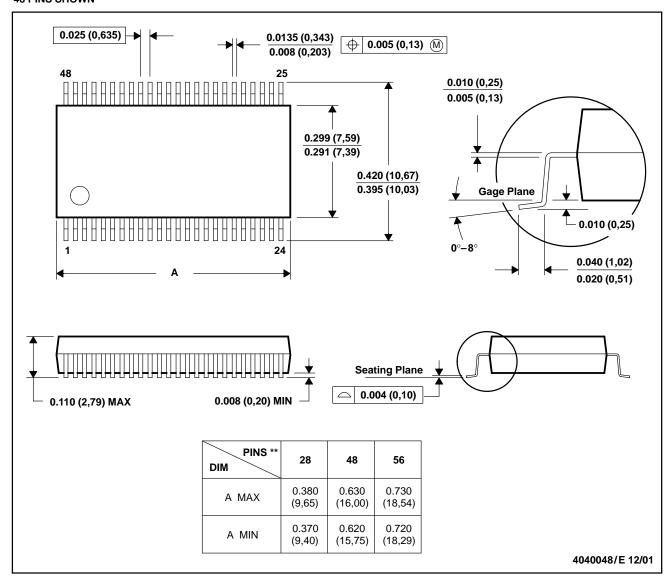


MECHANICAL DATA

MSSO001C - JANUARY 1995 - REVISED DECEMBER 2001

PLASTIC SMALL-OUTLINE PACKAGE

DL (R-PDSO-G**) 48 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118





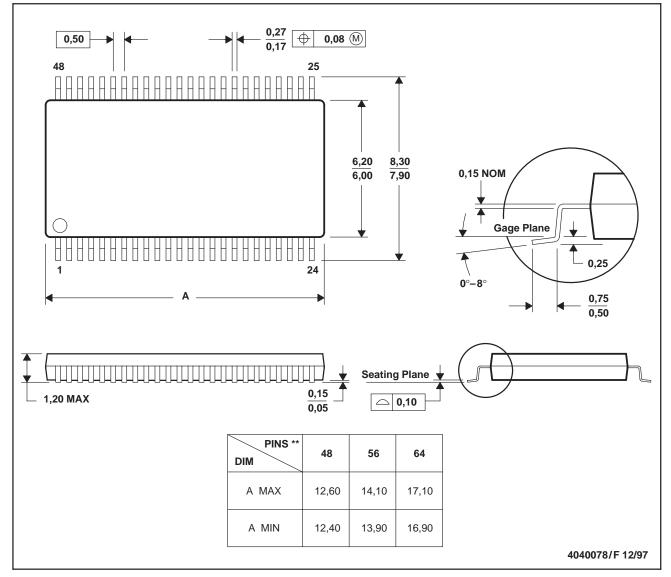
MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153



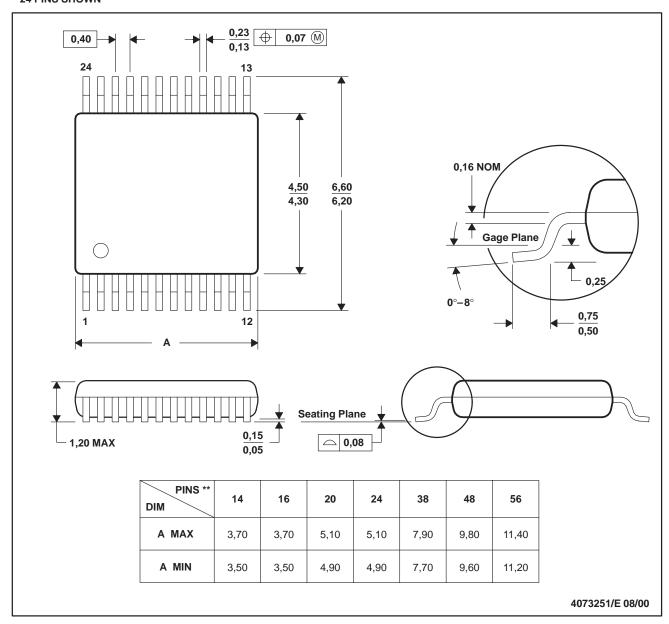


MECHANICAL DATA

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

PLASTIC SMALL-OUTLINE

DGV (R-PDSO-G**) 24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins - MO-153

14/16/20/56 Pins – MO-194





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